NPN SILICON PLANAR MEDIUM POWER HIGH GAIN TRANSISTOR

ZTX688B

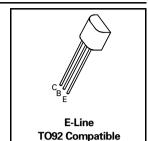
ISSUE 2 - MAY 94

FEATURES

- * 12 Volt V_{CEO}
- * Gain of 400 at I_C=3 Amps
- * Very low saturation voltage

APPLICATIONS

- * Darlington replacement
- * Flash gun convertors
- * Battery powered circuits
- * Motor drivers



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	VALUE	UNIT
Collector-Base Voltage	V _{CBO}	12	V
Collector-Emitter Voltage	V _{CEO}	12	V
Emitter-Base Voltage	V _{EBO}	5	V
Peak Pulse Current	I _{CM}	10	Α
Continuous Collector Current	I _C	3	Α
Practical Power Dissipation*	P _{totp}	1.5	W
Power Dissipation at T _{amb} =25°C derate above 25°C	P _{tot}	1 5.7	W mW/°C
Operating and Storage Temperature Range	T _j :T _{stg}	-55 to +200	°C

^{*}The power which can be dissipated assuming the device is mounted in a typical manner on a P.C.B. with copper equal to 1 inch square minimum

ELECTRICAL CHARACTERISTICS (at T_{amb} = 25°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	V _{(BR)CBO}	12			V	I _C =100μA
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	12			V	I _C =10mA*
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	5			V	I _E =100μA
Collector Cut-Off Current	I _{CBO}			0.1	μА	V _{CB} =10V
Emitter Cut-Off Current	I _{EBO}			0.1	μА	V _{EB} =4V
Collector-Emitter Saturation Voltage	V _{CE(sat)}			0.04 0.06 0.18 0.35	V V V	I _C =0.1A, I _B =1mA I _C =0.1A, I _B =0.5mA* I _C =1A, I _B =50mA* I _C =3A, I _B =20mA*
Base-Emitter Saturation Voltage	V _{BE(sat)}			1.1	V	I _C =3A, I _B =20mA*
Base-Emitter Turn-On Voltage	V _{BE(on)}			1	V	IC=3A, V _{CE} =2V*
Static Forward Current Transfer Ratio	h _{FE}	500 400 100				I _C =0.1A, V _{CE} =2V* I _C =3A, V _{CE} =2V* I _C =10A, V _{CE} =2V*

ELECTRICAL CHARACTERISTICS (at T_{amb} = 25°C)

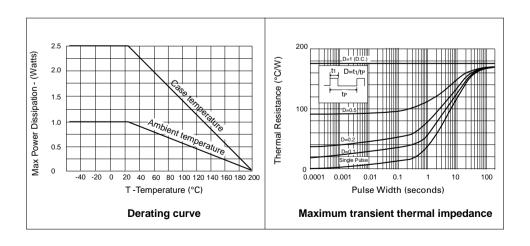
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Transition Frequency	f _T	150			MHz	I _C =50mA, V _{CE} =5V f=50MHz
Input Capacitance	C _{ibo}		200		pF	V _{EB} =0.5V, f=1MHz
Output Capacitance	C _{obo}		40		pF	V _{CB} =10V, f=1MHz
Switching Times	t _{on} t _{off}		40 500		ns ns	I _C =500mA, I _{B1} =50mA I _{B2} =50mA, V _{CC} =10V

^{*}Measured under pulsed conditions. Pulse width=300µs. Duty cycle ≤2%

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	MAX.	UNIT
Thermal Resistance:Junction to Ambient ₁ Junction to Ambient ₂ Junction to Case	R _{th(j-amb)1} R _{th(j-amb)2} † R _{th(j-case)}	175 116 70	°C/W °C/W

[†] Device mounted on P.C.B. with copper equal to 1 sq. Inch minimum.



ZTX688B

TYPICAL CHARACTERISTICS

